



*Annealing of Charge Collection
Efficiency in highly irradiated
low-resistivity MCz-p-on-n strip
detectors.*

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Motivations

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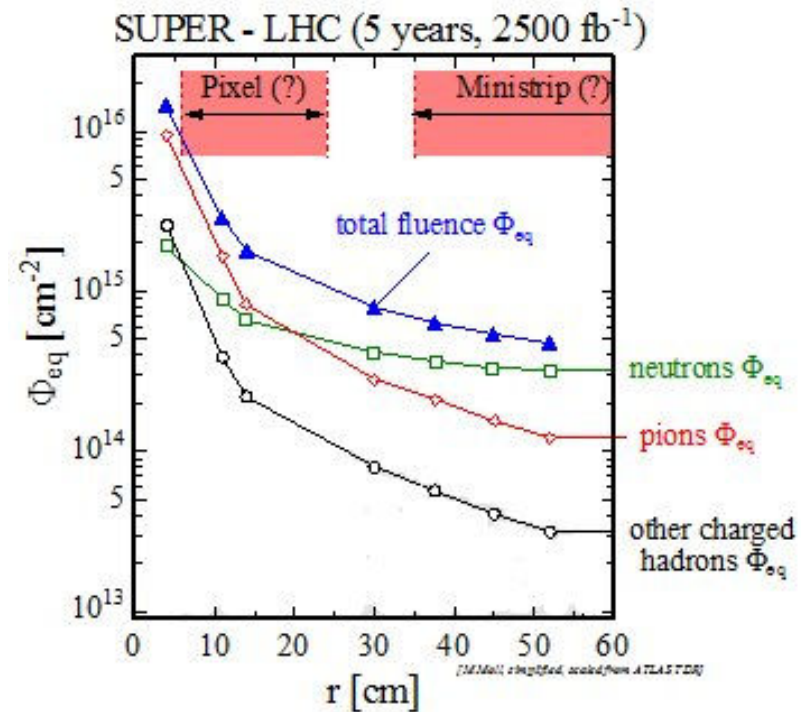
The most probable candidates technologies for the s-LHC upgrade are:

- n-in-p FZ silicon
- n-in-p MCz silicon
- n-in-n MCz silicon
- p-in-n MCz silicon

• p-bulk detector are the best performing choice, but at the present time engineering problems (strip insulation) are still present.

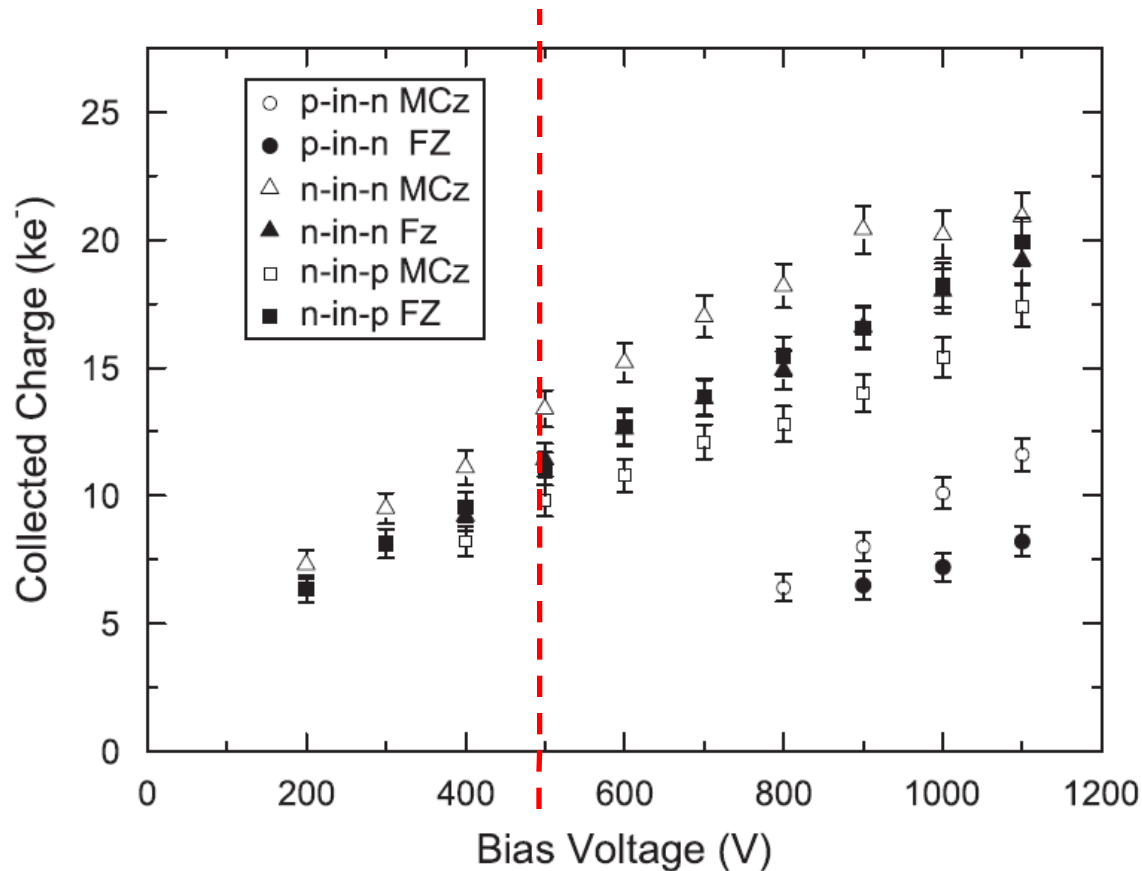
• Is it possible to use p-readout n-type MCz-silicon?

• Annealing – The current generation of detectors needs to be kept cold even during maintenance cycles. MCz-n-on-p has proven to keep a constant CCE even during annealing. Is the same true for MCz-p-on-n?



Previous studies on MCz-n: neutron study (Affolder)

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n-in-n MCz: 12.000e @ 500 V

n-in-p MCz: 9.000e @ 500 V

p-in-n MCz: no sig. @ 500 V

(In our study 15.000 e-, with depletion reached @ 800 V)

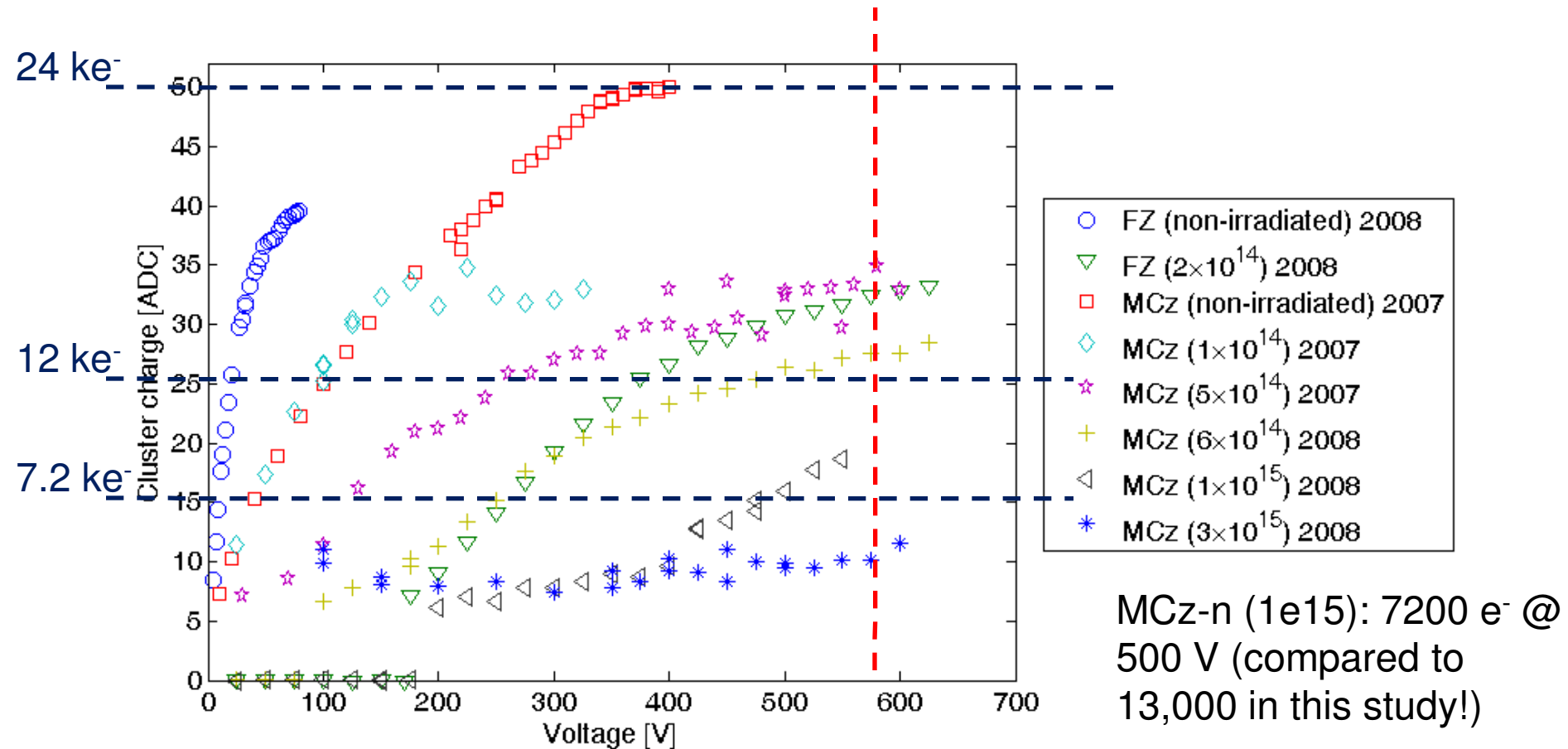
1.5 kOhm for ptype, 2 kOhm for ntype

A. Affolder et al. – NIMA 604 p. 250

Neutron irradiation – 10^{15} neutrons/cm²

Previous studies on MCz-n: CCE on test beam (Luukka et al.)

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P. Luukka et al. – NIMA 604 p. 254

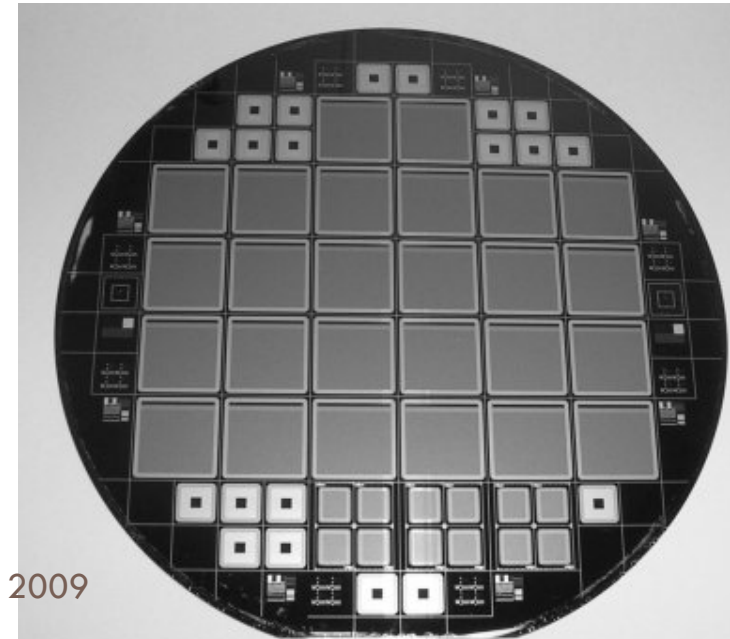
26 MeV proton irradiation – MCz-p-on-n

MCz-n irradiation

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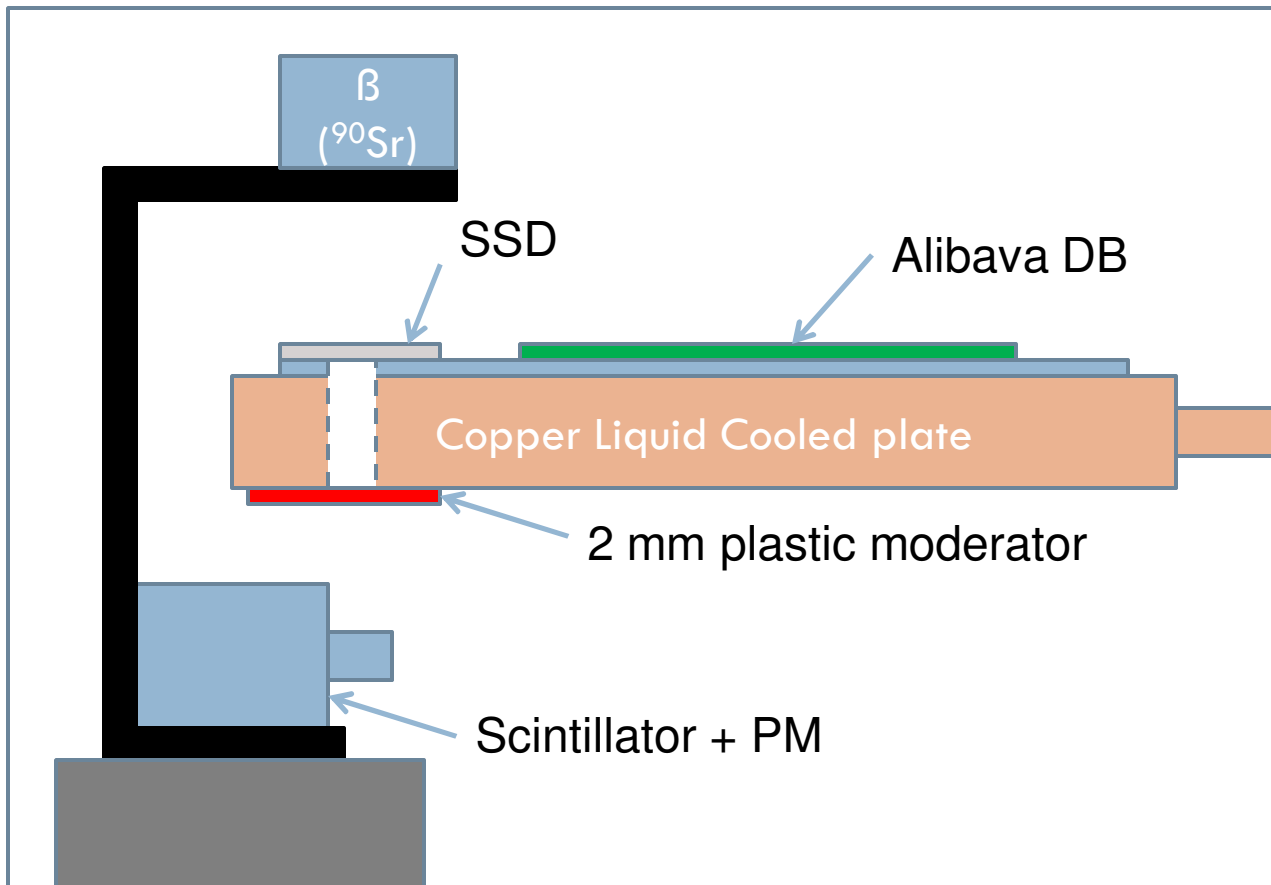
- RD50 production batch, 300 μm thickness, 80 μm strip pitch – expected resistivity 500 $\Omega\cdot\text{cm}$, actual resistivity $\sim 200 \Omega\cdot\text{cm}$ ($V_{\text{dep}} > 1000 \text{ V}$).
- Diodes from the same wafers irradiated at the same fluences.

Samples irradiated in Ljubljana in
February - March 2007
at fluences up to $8 \times 10^{15} \text{ n/cm}^2$



CCE Setup

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Setup is enclosed into a box with nitrogen flushing.

Detector is biased independently through an external bias filter (Alibava RC filter burned @ 1100 volts)

Beetle chip was operated at stable -20 ± 0.5 °C

Refer to Eduardo del Castillo presentation in Alibava session...

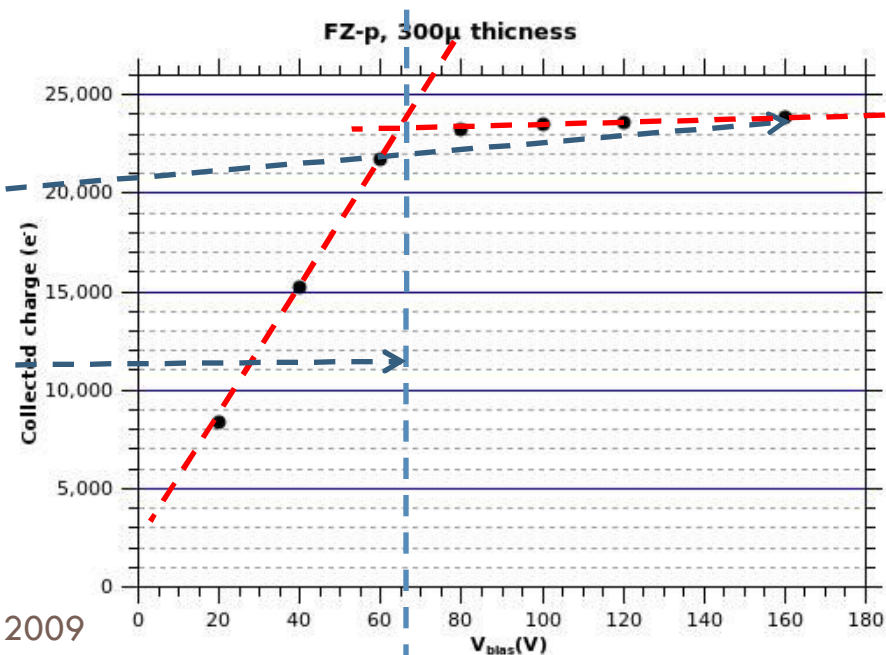
Setup Calibration

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- The calibration of the setup was performed in the 0-51200 e^- range.
- The calibration was done with unbonded beetle chips, at -20°C
- The calibration was cross-checked by measuring the CCE on an unirradiated FZ-p detector with $300\mu\text{m}$ thickness and $V_{fd}(\text{CV})=70\text{V}$

Collected charge: 23,860 h^+

Depletion voltage from strip CCE in agreement with CV measurements



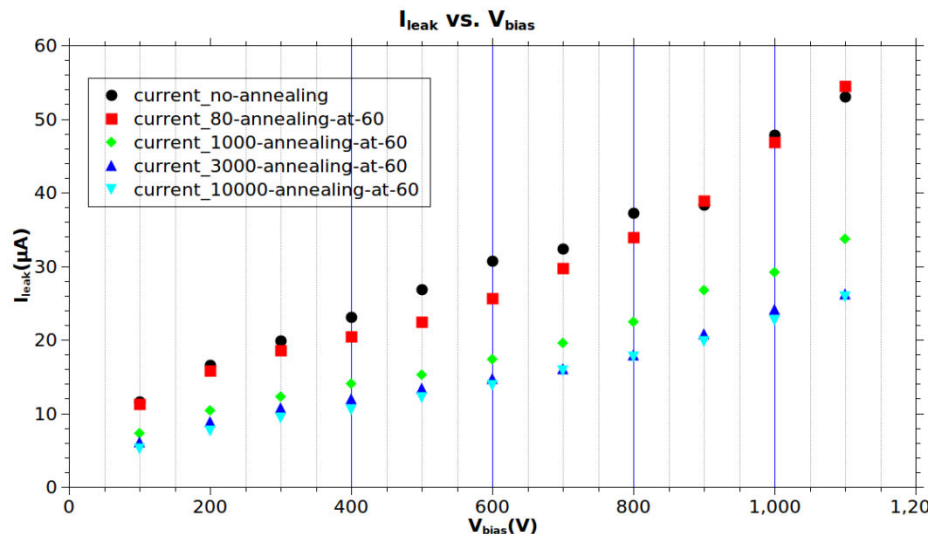
Annealing

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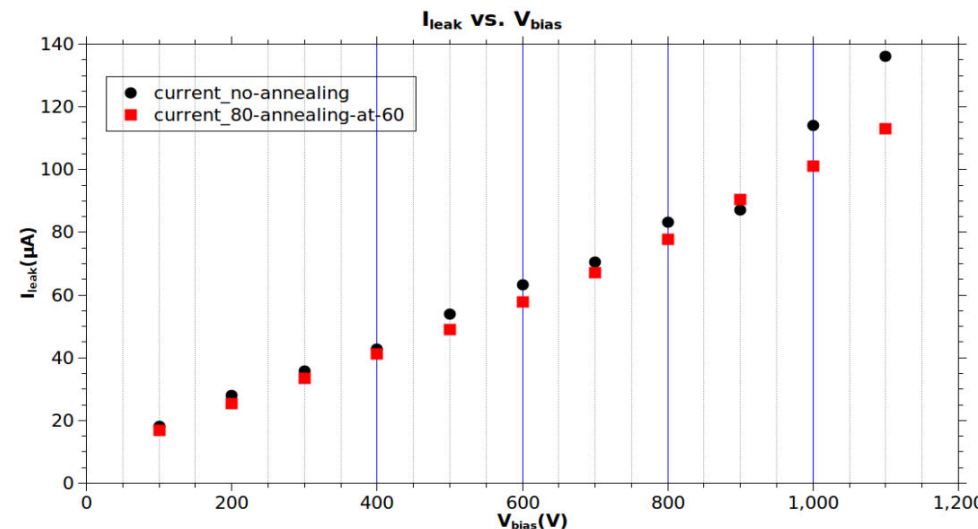
Detectors were annealed at 60 °C at 5 different steps: 0, 80, 1,000, 3,000, 10,000, without unbonding them from the Alibava daughterboard. The “low” annealing temperature was chosen to preserve the daughterboard from eventual damage.

(Current curves at different annealing steps. Current measured at -20 °C with RH<50%, bias+guard current)

1e15 n/cm²



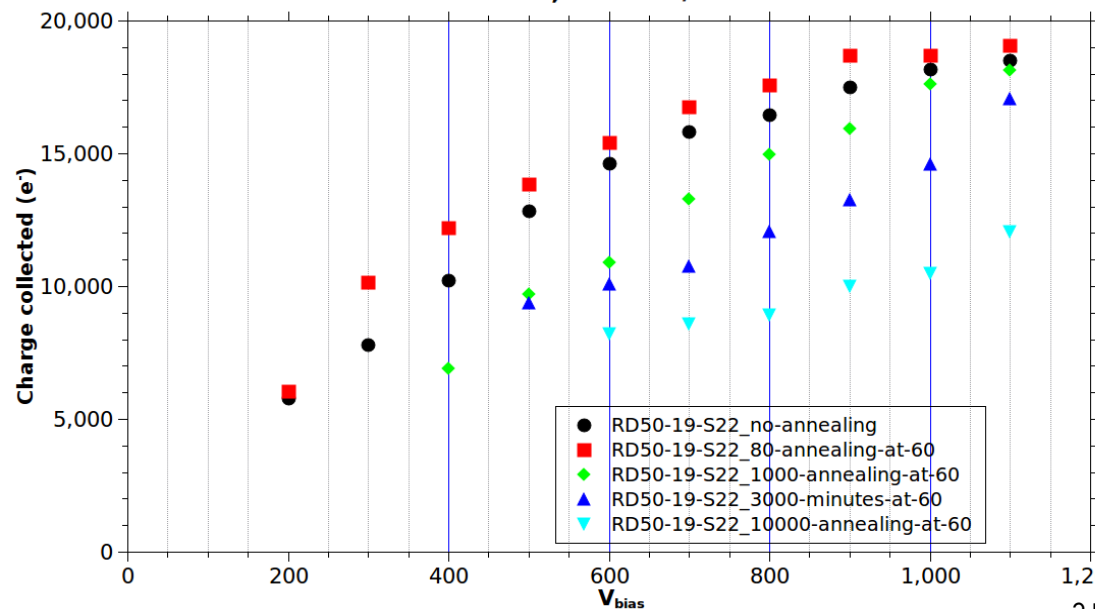
3e15 n/cm²



CCE Results: $1e15 \text{ n/cm}^2$

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RD50-19-S22, $1 \cdot 10^{15} \text{ n/cm}^2$

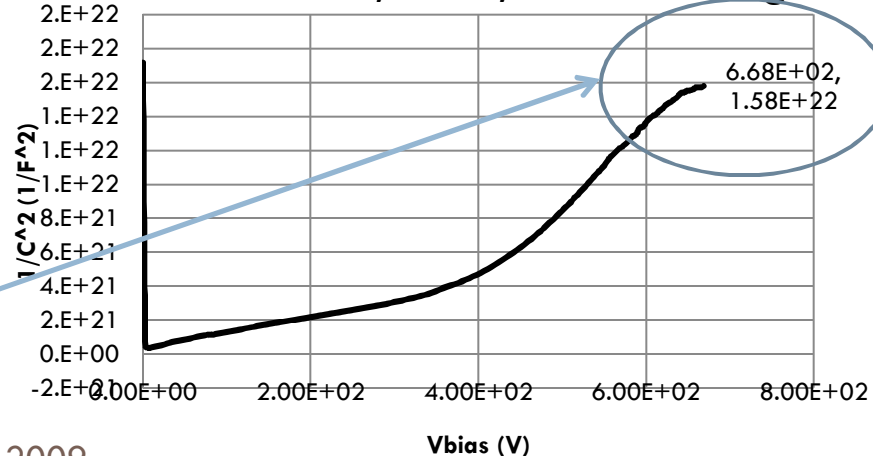


Collected charge goes down, but is appreciable even after long term annealing

At the first step of annealing, depletion voltage from CCE is compatible with CV on diode (about 700-800 V)

Depletion at @ ~ 700 V with no annealing

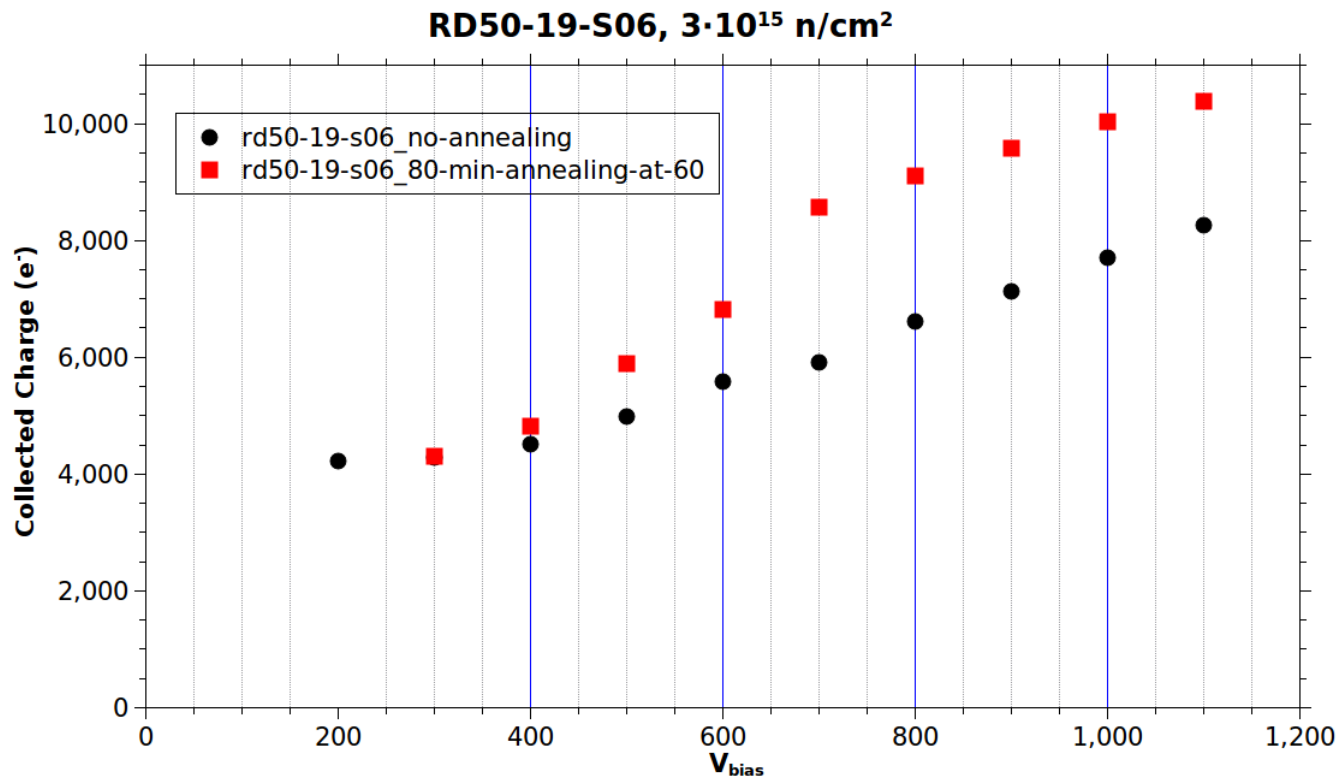
RD50-19-P03, $1e15$, no annealing



CCE Results: $3 \times 10^{15} \text{ n/cm}^2$

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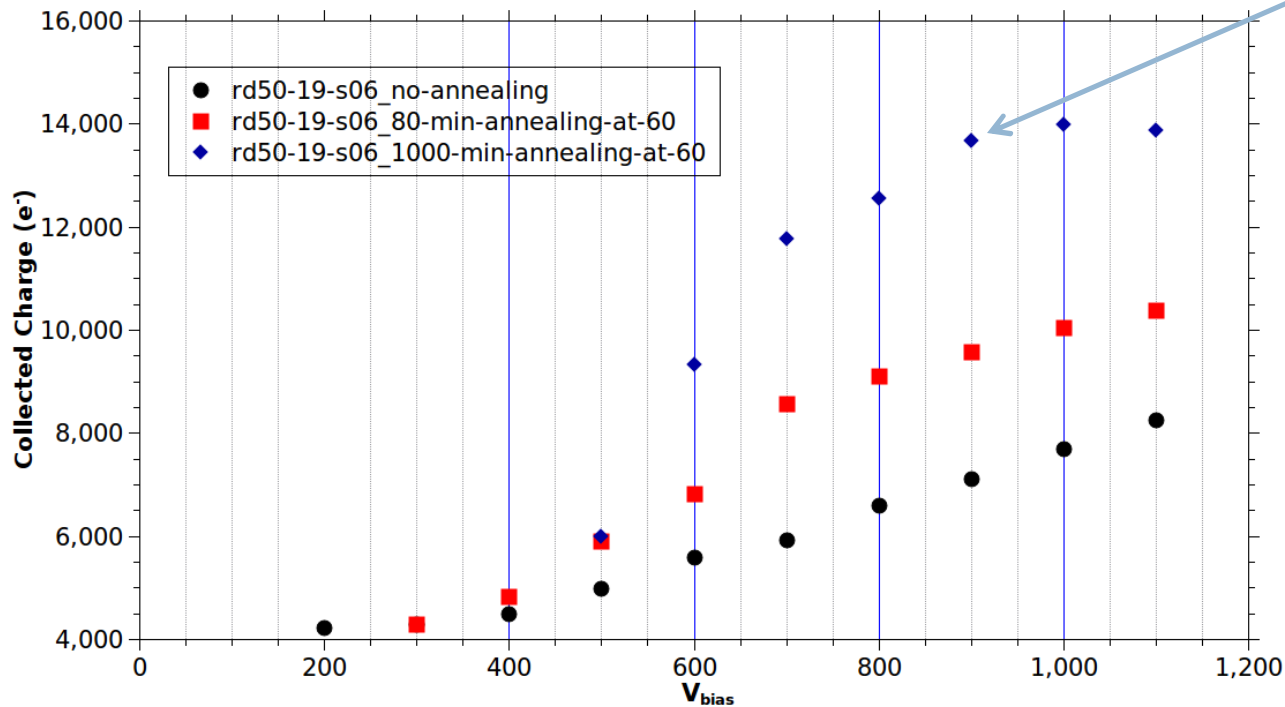
- Only 80 minutes annealing – after 3000 minutes the signal was not readable (baseline shift over the signal height, see next slide...)



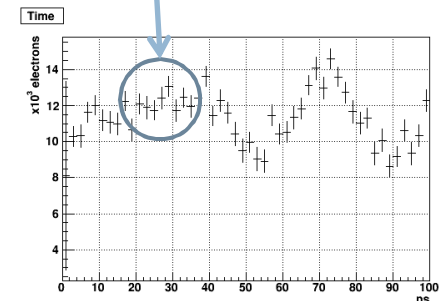
CCE Results: $3 \times 10^{15} \text{ n/cm}^2$

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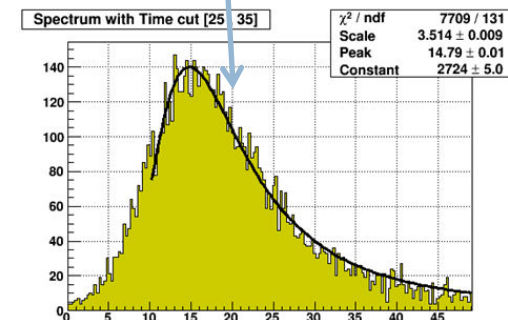
RD50-19-S06, $3 \cdot 10^{15} \text{ n/cm}^2$



This curve is not correct!!!: No semigaussian peak visible, just baseline shift!



Produces a very nice Landau, though...

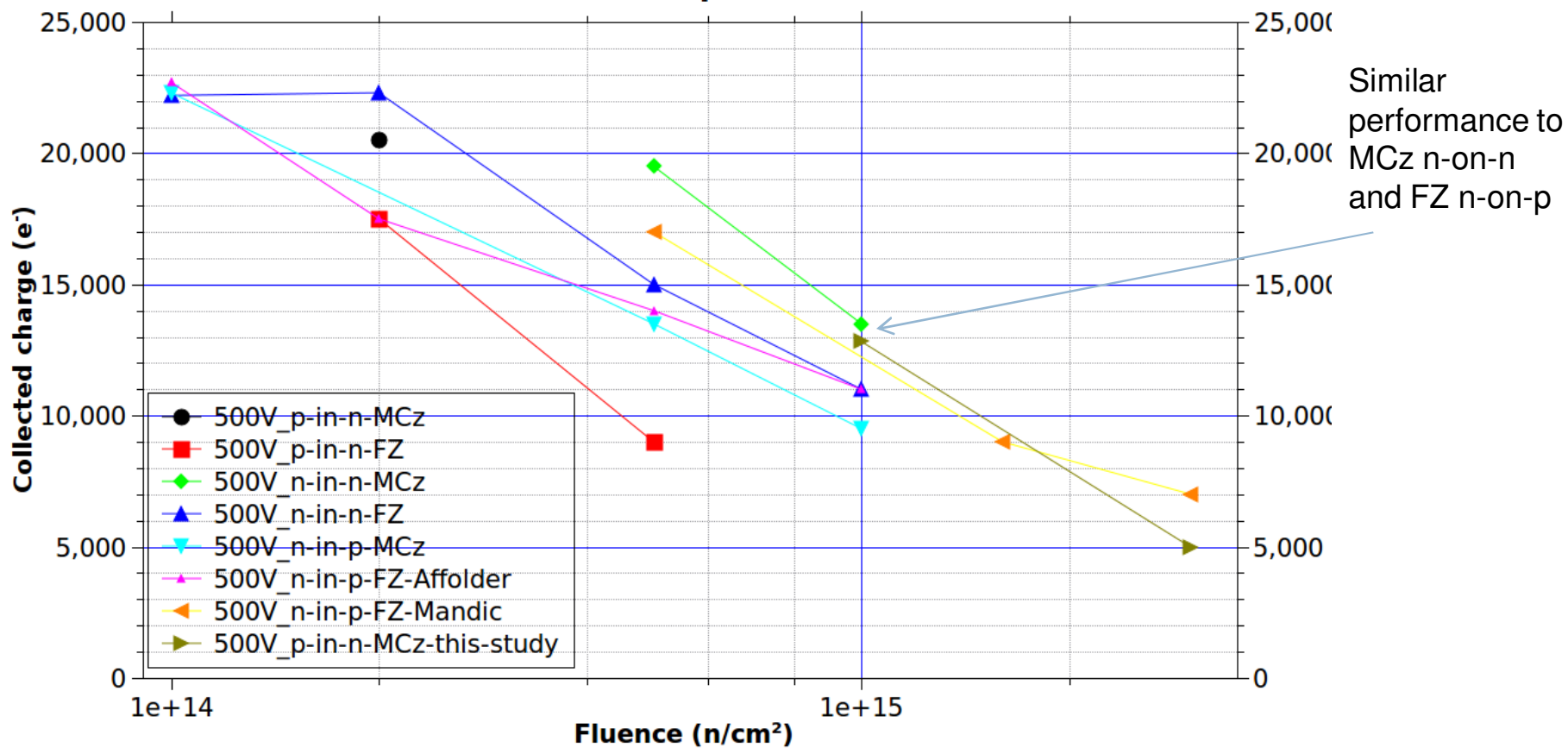


Efficiency omparison with existing results (500 V)

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Data compared with equivalent study made on various type of detectors and published by A. Affolder on NIMA 604 and by Mandic on NIMA 603.

500 V Comparison

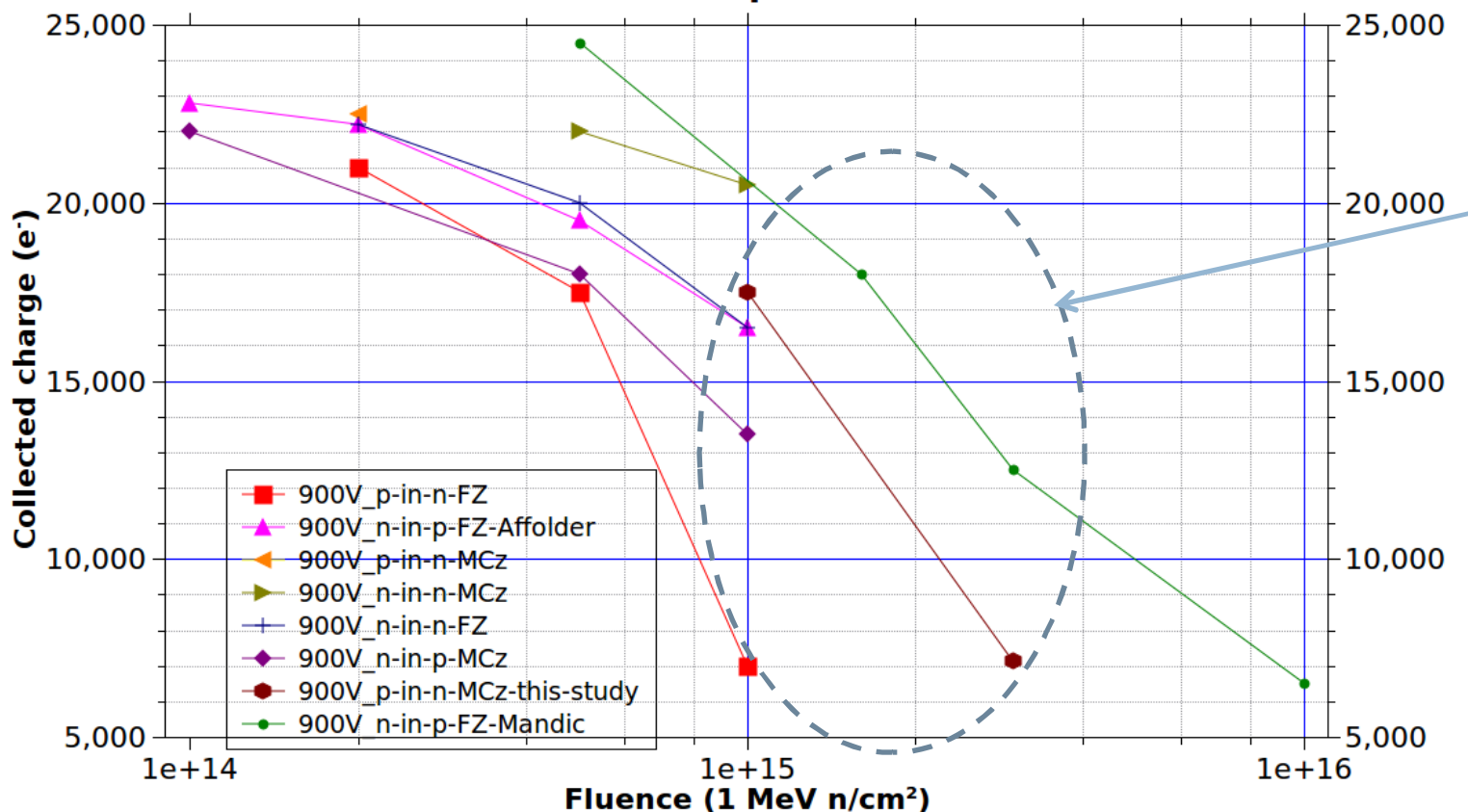


Efficiency comparison with existing results (900 V)

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Data compared with equivalent study made on various type of detectors and published by A. Affolder on NIMA 604 by Mandic on NIMA 603.

900 V comparison



At higher fluence performance degrades slightly compared to MCz n-in-n and FZ n-in-p

Conclusions

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- Low resistivity MCz-n shows good CCE after neutron irradiation. A proton study is ongoing, as well as a CCE study on lower fluences.
- Differences are evident in terms of better charge collection efficiency as compared to standard “high resistivity” MCz p-on-n detectors. This is probably due to the shifting of SCSI to higher fluences.
- Reverse annealing decreases the performance of the detector, but for fluences up to $1e15$ the collected charge is reasonable even after 10.000 mins at 60°C
- The real limiting factor in operating the detector irradiated at $8e15$ was the too high current. A more powerful cooling is required.

Further notes

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- 8×10^{15} irradiated samples was not measurable – No signal up to 500 V. For higher voltages -20C cooling was not sufficient to keep current below 1 mA.
- Position-sensitive strip TCT will be performed on a twin set of samples, from the same wafer, to assess the effect of irradiation on electric fields

□ Thank you!

Discussion session

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- RC bias filter cannot withstand more than 1 000 V (no tolerance at all!)
- Gaussian + Landaul fit: is the gaussian convolution just for taking care of the noise? A few objections:
 - The noise subtraction should take away all the noise, tails included
 - We're talking about a convolution, not a SUM(!!!) – Manuel pointed out that in CMS the gaussian convolution is used to account for the jitter in the signal sampling – In this case we should check whether with Alibava we need it or not
- Here at CERN a Daughterboard suddenly died after 3 annealing steps showing quite a weird behaviour in the baseline of the signal... any clue?
- If the sampling of the Alibava happens at 25 ns steps, where is generated the nice 2 ns – resoluted plot shown in the main output of the root macros? Is there a 500 MHz ADC somewhere?
- By using more times the pitch adapters, the bond wires will get longer, thus changing the capacitance seen by the beetle. Is there any parameter to adjust to compensate for this?